DISCRETE SEMICONDUCTORS

DATA SHEET

PDTC114Y series NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

Product specification Supersedes data of 2003 Sep 10 2004 Aug 17





NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PDTC114Y series

FEATURES

- Built-in bias resistors
- · Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- · General purpose switching and amplification
- · Inverter and interface circuits
- Circuit driver.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	_	50	V
I _O	output current (DC)	_	100	mA
R1	bias resistor	10	_	kΩ
R2	bias resistor	47	_	kΩ

DESCRIPTION

NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TYPE NUMBER	PAC	KAGE	MARKING CORE	PNP COMPLEMENT
I TPE NUMBER	PHILIPS	EIAJ	MARKING CODE	PNP COMPLEMENT
PDTC114YE	SOT416	SC-75	33	PDTA114YE
PDTC114YEF	SOT490	SC-89	12	PDTA114YEF
PDTC114YK	SOT346	SC-59	47	PDTA114YK
PDTC114YM	SOT883	SC-101	DU	PDTA114YM
PDTC114YS	SOT54 (TO-92)	SC-43	TC114Y	PDTA114YS
PDTC114YT	SOT23	_	*27 ⁽¹⁾	PDTA114YT
PDTC114YU	SOT323	SC-70	*30(1)	PDTA114YU

Note

^{1. * =} p: Made in Hong Kong.

^{* =} t: Made in Malaysia.

^{* =} W: Made in China.

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PDTC114Y series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	CIMPLIFIED OUTLINE AND CYMPOL		PINNING
TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PIN	DESCRIPTION
PDTC114YS		1	base
		2	collector
	R1 R1 R2	3	emitter
PDTC114YE PDTC114YEF PDTC114YK PDTC114YT PDTC114YU	Top view 3 1 R1 R2 MDB269	1 2 3	base emitter collector
PDTC114YM	2 R1 R2 2 bottom view MHC506	1 2 3	base emitter collector

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PDTC114Y series

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	50	V
V _{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	10	V
V _I	input voltage				
	positive		_	+40	V
	negative		_	-6	V
Io	output current (DC)		_	100	mA
I _{CM}	peak collector current		_	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT54	note 1	_	500	mW
	SOT23	note 1	_	250	mW
	SOT346	note 1	_	250	mW
	SOT323	note 1	_	200	mW
	SOT416	note 1	_	150	mW
	SOT883	notes 2 and 3	_	250	mW
	SOT490	notes 1 and 2	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μm copper strip line.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT416	note 1	833	K/W
	SOT883	notes 2 and 3	500	K/W
	SOT490	notes 1 and 2	500	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

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PDTC114Y series

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0	_	_	100	nA
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0	_	_	1	μΑ
		V _{CE} = 30 V; I _B = 0; T _j = 150 °C	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	_	_	150	μΑ
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 5 mA	100	_	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 5 mA; I _B = 0.25 mA	_	_	100	mV
$V_{i(off)}$	input-off voltage	$I_C = 100 \mu\text{A}; V_{CE} = 5 \text{V}$	_	0.7	0.5	V
V _{i(on)}	input-on voltage	I _C = 1 mA; V _{CE} = 0.3 V	1.4	0.8	_	V
R1	input resistor		7	10	13	kΩ
R2 R1	resistor ratio		3.7	4.7	5.7	
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 10 V; f = 1 MHz	_	-	2.5	pF

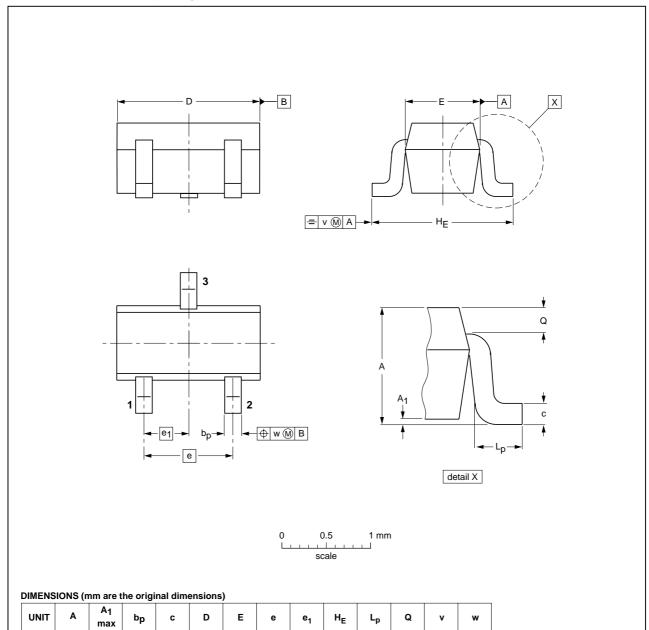
NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PDTC114Y series

PACKAGE OUTLINES

Plastic surface mounted package; 3 leads

SOT416



OUTLINE REFERENCES					EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT416			SC-75			97-02-28

1.75

1

0.5

0.45

0.23

0.2

0.2

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0.30

0.95

0.1

0.25

0.10

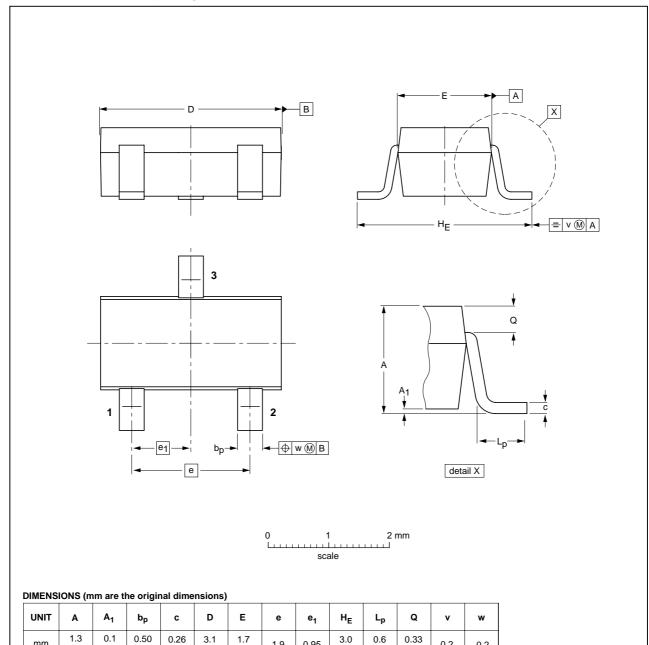
1.8

NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PDTC114Y series

Plastic surface mounted package; 3 leads

SOT346



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	
SOT346		TO-236	SC-59		98-07-17

0.95

0.2

0.2

1.9

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1.0

0.013

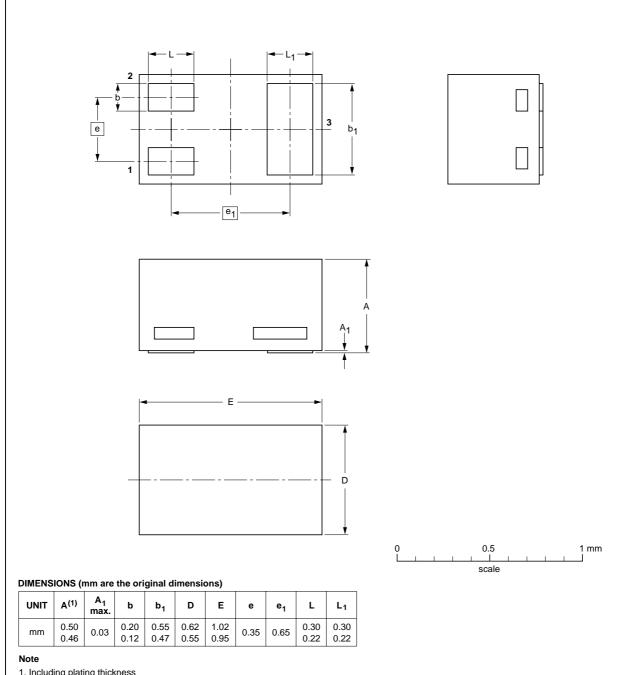
0.35

NPN resistor-equipped transistors; $R1 = 10 \text{ k}\Omega$, $R2 = 47 \text{ k}\Omega$

PDTC114Y series

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883



1. Including plating thickness

OUTLINE		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT883			SC-101		03-02-05 03-04-03

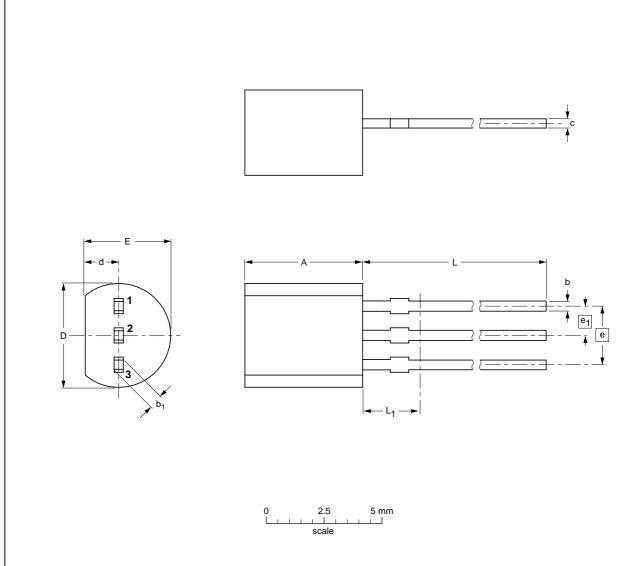
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NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PDTC114Y series

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

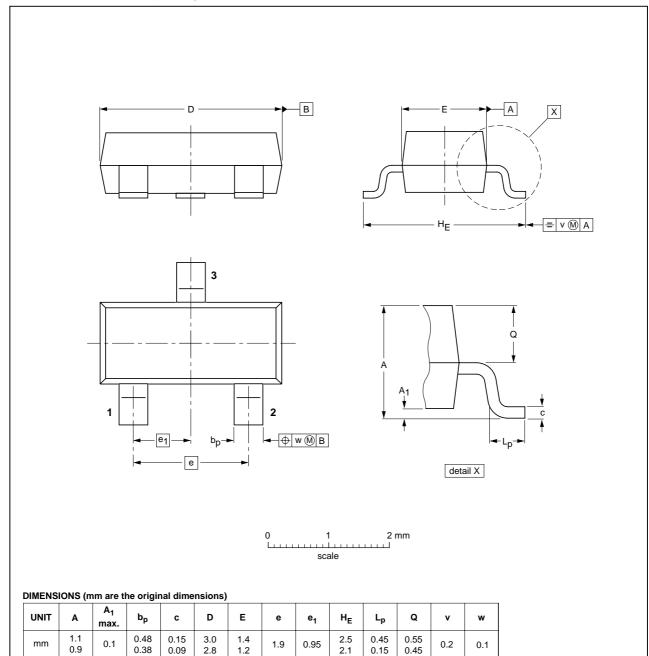
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	1330E DATE
SOT54		TO-92	SC-43A		97-02-28 04-06-28

NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PDTC114Y series

Plastic surface mounted package; 3 leads

SOT23



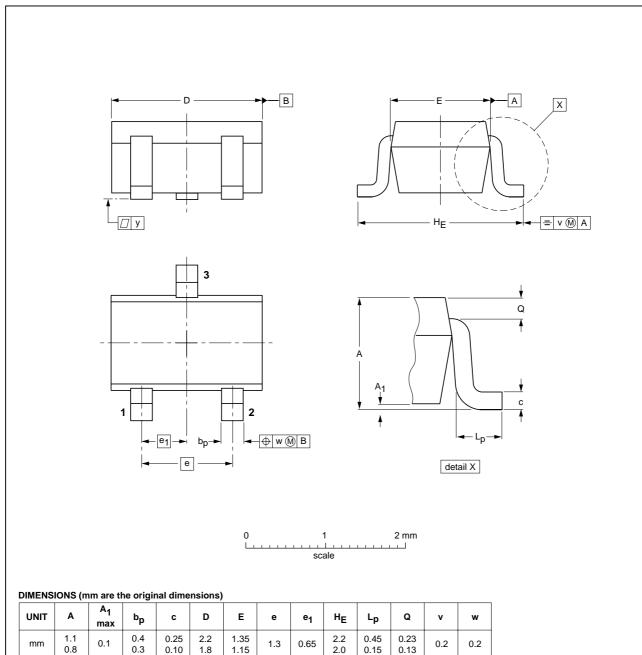
OUTLINE		REFER	ENCES		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	EIAJ PROJECTIOI		ISSUE DATE
SOT23		TO-236AB				-97-02-28 99-09-13

NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PDTC114Y series

Plastic surface mounted package; 3 leads

SOT323



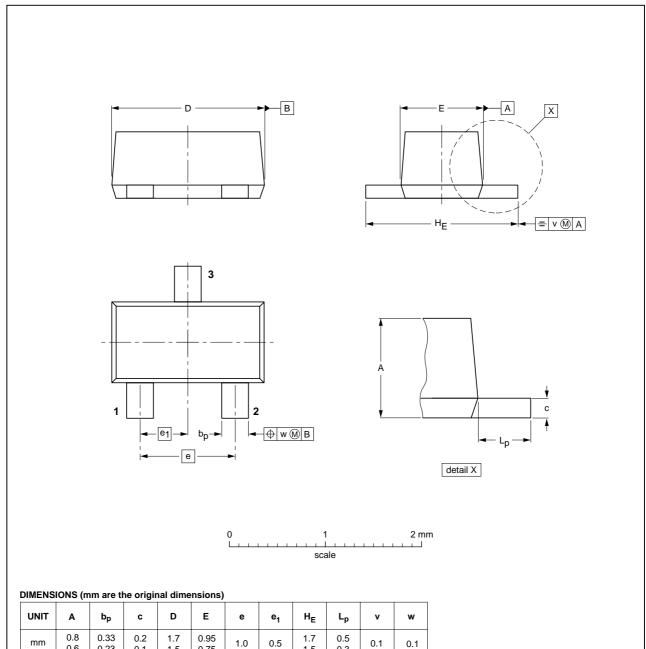
OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT323			SC-70			97-02-28

NPN resistor-equipped transistors; $R1 = 10 \text{ k}\Omega$, $R2 = 47 \text{ k}\Omega$

PDTC114Y series

Plastic surface mounted package; 3 leads

SOT490



OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT490			SC-89			98-10-23

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0.6

NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

PDTC114Y series

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

R75/06/pp14

Date of release: 2004 Aug 17

Document order number: 9397 750 13665

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